<i>*</i>		REVISIONS		
SYMBOL	PREP BY	DESCRIPTION	DATE	APPROVAL
А	M. Lennon	Table II Lead Material was WD7	10/3/86	JHK IOS
В	M. Lennon	3.2 Physical dimensions 2.92 mm dia. +,254 was 3.175 mm max. 3.4.5 Fourth sentence was "No heat sinks"	3/21/88	AN DEC

PREPARED BY CHAMPEN	DATE	
Matthew J. Lennon /Sperry Systems Mgmt.	31 Jul 86	TITLE
APPROVED Kiernan / Sperry Systems Mgmt.	8/8/86	Thermistor (Thermally Sensitive Resistor), Insulated, Negative
John Henegat GSFC	8-15-86	Temperature Coefficient, Super Stable, Glass Encapsulated,
D. G. Cleveland /GSFC	8.15.84	Style 311-424, Specification for
-		
		#S-311-424B.

Office of Flight Assurance Parts Branch



National Aeronautics and Space Administration



Goddard Space Flight Center Greenbelt, Maryland 20771

CONTENTS

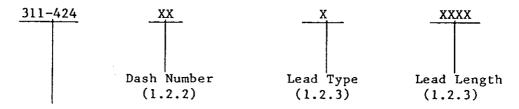
	• =	Page
1.	SCOPE	1
2.	APPLICABLE DOCUMENTS	3
3.	REQUIREMENTS	4
4.	QUALITY ASSURANCE PROVISIONS	12
5.	PREPARATION FOR DELIVERY	15
6.	NOTES	17
	ILLUSTRATIONS	
Fig	ure	Page
1	. Thermistor Configuration	4
2	. Test Circuit for Measuring Dissipation Constant	,7
3	. Test Circuit for Measuring Thermal Time Constant	10
	TABLES	
Tab	<u>le</u>	Page
1	Zero-Power Resistance at 25°C and Interchangeability Tolerance	1-2
II	Lead Configuration	3
III	Recommended Operating Range and Tolerance % Resistance and Degree C	5
IV	Thermistor Resistance Versus Temperature	8-9
V	Qualification Inspection	13
VI	Resistance Temperature Characteristic Test Temperatures	14
VII	Group A Inspection	15

1.0 SCOPE

1.1 This specification covers the detail requirements for Hermetic Glass Encapsulated Thermistors to be used for temperature control and measurement over the specified temperature range, during extended flight in space or in sensitive ground equipment. The maximum working temperature for these devices is 125°C.

1.2 CLASSIFICATION

1.2.1 Type Designation The type designation shall be in the following form.



GSFC Prefix (Standard for all Glass Encapsulated Thermistors)

1.2.2 Dash Number The dash number corresponds to the zero-power resistance at +25°C of the thermistor for three levels of interchangeability tolerance. These values are listed in Table I.

TABLE I
Zero-power Resistance @+25°C and Interchangeability Tolerance

Dash Number	Zero-Power Resistance Ohms @+25°C	Interchangeability Tolerance O to 70°C Degrees C	Tolerance %R O to 70°C	Resistance Ratio 25 to 125°C
11	2252	<u>+</u> 0.2	<u>+</u> 1.02	29.26
12	3000	<u>+</u> 0.2	<u>+</u> 1.02	29.26
13	5000	<u>+</u> 0.2	+1.02	29.26
14	10000	<u>+</u> 0.2	<u>+</u> 0.93	23.51
15	10000	<u>+</u> 0.2	<u>+</u> 1.02	29.26

TABLE I (continued)

Zero-power Resistance @+25°C and Interchangeability Tolerance

		· · · · · · · · · · · · · · · · · · ·		
Dash	Zero-Power Resistance Ohms @+25°C	Interchangeability Tolerance O to 70°C Degrees C	Tolerance %R O to 70°C	Resistance Ratio 25 to 125°C
16	30000	<u>+</u> 0.2	<u>+</u> 1.00	29.15
17	2252	<u>+</u> 0.1	<u>+</u> 0.51	29.26
18	3000	<u>+</u> 0.1	+0.51	29.26
19	5000	<u>+</u> 0.1	<u>+</u> 0.51	29.26
20	10000	<u>+</u> 0.1	+0.48	23.51
21	10000	<u>+</u> 0.1	<u>+</u> 0.51	29.26
22	30000	<u>+</u> 0.1	+0.50	29.15
23	2252	<u>+</u> 0.05	+0.26	29.26
24	3000	<u>+</u> 0.05	<u>+</u> 0.26	29.26
25	5000	<u>+</u> 0.05	<u>+</u> 0.26	29.26
26	10000	<u>+</u> 0.05	<u>+</u> 0.24	23.51
27	10000	+ 0.05	<u>+</u> 0.26	29.26

1.2.3 <u>Lead Configuration</u> The identification of the lead configuration to be included in the Type designation for material and lead length shall be as listed in Table II.

Table II Lead Configuration

Lead Type	Lead Material	Lead Length
S	#32 AWG, Type WD2 per Mil-Std-1276	Four spaces (XXXX) indicate length in centimeters. Example: 7R6 - 7.6 cm Standard
Е	Insulated Lead - TFE #30 AWG per Mil-I-22129 Bare lead - S	10R2 - 10.2 cm 12R8 - 12.8 cm 15R2 - 15.2 cm <u>Maximum</u> <u>1</u> /

 $[\]underline{1}$ / Longest available without special negotiation.

2.0 APPLICABLE DOCUMENTS

2.1 The following documents of the issue in effect on the date of invitation for proposal, form a part of this specification to the extent specified herein. In the event of a conflict between this specification and any document referenced here-in this specification will govern.

Federal		
PPP-B-566		Boxes Folding Paperboard
PPP-B-636		Box, Fiberboard
PPP-B-676		Boxes, Set-up
PPP-T-60	-	Tape: Pressure-sensitive adhesive, Waterproof for packaging.
PPP-T-76	-	Tape, Packaging Paper (for carton sealing)
Military		
MIL-P-116		Preservation Methods of
MIL-W-16878		Wire, Electrical Insulated, High Temperature
MIL-I-22129		Insulation Tubing, Electrical, Polytetrafluorethyline Resin, Non-rigid
MIL-T-23648		Thermistor, (Thermally Sensitive Resistor) Insulated
MIL-C-45622		Calibration System Requirements
Military Stand	ards	
MIL-STD-129	_	Marking for Shipment and Storage
MIL-STD-202D		Test Methods for Electronic and Electrical Component Parts
MIL-STD-1276	-	Leads for Electronic Component Parts

3.0 REQUIREMENTS

3.1 General. Thermistors shall be tested by MIL-T-23648 methods and shall meet the test requirements specified here-in. The recommended operating temperature range and tolerance in percentages of resistance and degrees Celsius (C) are listed in Table III.

3.2 Physical and mechanical

3.2.1 Outline Dimensions The outline dimensions shall comply with either Figure la or lb.

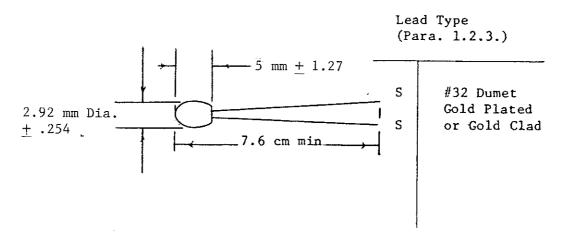


Figure la.

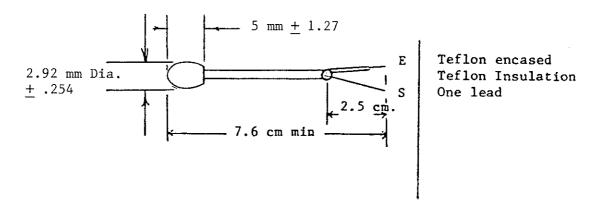


Figure 1b

Figure 1. Thermistor Configuration

Table III
Recommended Operating Range & Tolerance
(± % Resistance and ± Degrees C)

t	 	 	}	·	+	<u> </u>	
Dash No.	-80°C	-40°C	0°C	+40°C	+70°C	+100°C	+125°C
11 12 13 15	1.00°C 8.6%	0.40°C 2.65%	0.20°C 1.02%	0.20°C 0.80%	0.20°C 0.68%	0.30°C 0.88%	0.65°C 1.7%
14	1.00°C 7.4%	0.40°C 2.37%	0.20°C 0.93%	0.20°C 0.74%	0.20°C 0.64%	0.30°C 0.83%	0.65°C 1.6%
16		0.40°C 2.50%	0.20°C 1.00%	0.20°C 0.80%	0.20°C 0.68%	0.30°C 0.88%	0.65°C 1.74%
17 18 19 21		0.20°C 1.33%	0.10°C 0.51%	0.10°C 0.40%	0.10°C 0.34%	0.15°C 0.44%	
20		0.40°C 2.37%	0.10°C 0.48%	0.10°C 0.37%	0.10°C 0.32%	0.30°C 0.83%	
22	-	0.20°C 1.25%	0.10°C 0.50%	0.10°C 0.40%	0.10°C 0.34%	0.15°C 0.44%	
23 24 25 27	em not		0.05°C 0.26%	0.05°C 0.20%	0.05°C 0.17%		
26	<u></u>		0.05°C 0.24%	0.05°C 0.20%	0.05°C 0.16%		

- 3.2.2 Coating Thermistor elements shall be coated with a uniform coating of glass.
- 3.2.3 Terminal Strength (Pull) Thermistors leads shall be subjected to 0.5 lb pull per Method 211, MIL-STD-202, Test Condition A, and shall incur no mechanical damage nor thereafter feature change in 40°C zero power resistance shall not exceed 0.5%.
- 3.2.4 Workmanship Thermistors shall be clean and free of foreign material and when viewed under 10X magnification shall be seen to be free of the following.
 - (a) Cracks in the glass or open voids
 - (b) Damaged wire leads by nicks or crushing
- 3.2.5 Solderability When thermistors are tested in accordance with Method 208 of MIL-STD-202 the dipped surface of the leads shall be at least 95 percent covered with a new solder coating. The remaining 5 percent of the lead surface shall show only small pinholes or voids and these shall not be concentrated in one area. Bare base metal shall not show and is cause for rejection as evidence of poor solderability.

3.3 Electrical

- 3.3.1 Zero Power Resistance The zero power values at 25°C shall be as specified in Table I. The zero power resistance values at temperatures over the temperature range -80°C to +125°C are as specified in Table IV.
 - (a) Measurement shall be made by submerging the thermistor in a well-stirred oil bath. The oil bath temperature shall be measured prior to, during and after the test. The temperature of the bath shall be measured and recorded within an accuracy of ±0.05°C.
 - (b) Dissipated power during the measurement shall not exceed 0.1 mw maximum.
- 3.3.2 Short Time Load Thermistors shall be mounted by normal mounting means in corrosion resistance clips.
 - (a) Using the value of dissipation constant and nominal resistance, compute the average value of voltage across the thermistor (E_{TH}) and current through the thermistor (I_{TH}) required to raise the thermistor to maximum power rating. Place the thermistor in the circuit of Figure 2 to accomplish this.
 - (b) Energize the circuit for 5 minutes. The maximum allowable change in 40°C zero power resistance as a result of the short time load test shall be 1%.
 - (c) De-energize the circuit for 10 minutes. Repeat this cycle for 10 complete cycles.
 - (d) Examine the thermistors for evidence of arcing, burning or charring and reject if such occurs.

- (e) Sixty minutes after removal from cycling, the zero power resistance shall be measured as in 3.3.1 and must be as specified in Table II.
- 3.3.3 Insulation Resistance The thermistor insulation resistance shall be tested in accordance with Method 302 of MIL-STD-202, Test Condition A (100v), and shall be greater than 500 megohms.
- 3.3.4 Dissipation Constant The dissipation constant is the ratio (in milliwatts per degree C) at a specified ambient temperature, of a change in power dissipation in a thermistor to the resultant body temperature change. The dissipation constant shall be greater than or equal to 1.0 milliwatt per degree Celsius in still air.
- 3.3.4.1 Measure the dissipation constant, P, using the test circuit of Figure 2. First measure the zero power resistance at two temperatures, 25°C and 75°C, per 3.3.1. Place the thermistor in a still air controlled chamber with a minimum volume of 1000 times the thermistor body and test fixture volume. The chamber temperature shall be at 25 \pm 1°C. Adjust E_{TH} and I_{TH} for zero power resistance values of 75°C and maintain for 15 minutes maximum. Compute the dissipation constant in mw/°C using:

$$\frac{P}{50} = \frac{E_{TH} \times I_{TH}}{75 \text{ C}-25 \text{ C}}$$

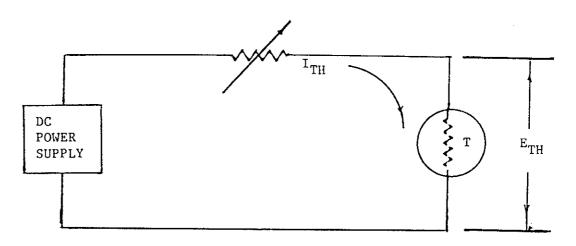


Figure 2. Test Circuit for Measuring Dissipation Constant

- 3.3.5 Thermal Time Constant The thermal time constant is the time required for the thermistor to change 63.2% of the total difference between its initial and final body temperature when subjected to a step function change in temperature under zero-power condition and shall not exceed 30 seconds in still air.
- 3.3.5.1 Measure the time constant using the test circuit of Figure 3. Measure and record the zero-power resistance at 43.4°C and 75°C per 3.3.1. Place the thermistor in a still air chamber maintained at 25 ± 1°C, with a minimum volume of 1000 times the thermistor body and test

Table IV

Resistance Versus Temperature °C

	.				·	
Dash No.	11 17 23	12 18 24	13 19 25	15 21 27	14 20 26	16 22
Ohms @ 25°C	2252	3000	5000	10,000	10,000	30,000
Temp °C			Ohms	******		Ť
-80 -75 70 65 60 55 50 45 40 -35 30 25 20 15 10 5 0 + 5 10 15 20 25 30 35 40	1660K 1071K 702.3K 467.9K 316.5K 217.1K 151.0K 99.26K 75.79K 54.66K 39.86K 29.38K 21.87K 16.43K 12.46K 9534 7355 5719 4482 3539 2814 2252 1815 1471 1200	2211K 1426K 935.4K 623.3K 421.5K 289.2K 201.1K 132.2K 101.0K 78.81K 53.10K 39.13K 29.13K 21.89K 16.60K 12.70K 9796 7618 5971 4714 3748 3000 2417 1959 1598	3685K 2378K 1560K 1039K 702.9K 482.2K 335.3K 220.5K 168.3K 121.4K 88.53K 65.24K 48.56K 36.49K 27.67K 21.17K 16.33K 12.70K 9951 7857 6247 5000 4029 3266 2663	7371K 4756K 3119K 2018K 1405K 964.0K 670.5K 440.8K 336.5K 242.K 177.0K 130.5K 97.11K 72.96K 56.33K 42.34K 32.66K 25.40K 19.90K 15.71K 12.50K 10.00K 8060 6532 5329	3558K 2440K 1694K 1190K 845.9K 607.K 441.3K 304.6K 239.8K 179.2K 135.2K 102.9K 78.91K 61.02K 47.54K 37.31K 29.49K 23.46K 18.79K 15.13K 12.26K 10.00K 8194 6752 5592	884.6K 649.3K 481.0K 359.6K 271.2K 206.2K 158.0K 122.1K 94.98K 74.44K 58.75K 46.67K 37.30K 30.00K 24.27K 19.74K 16.15K
+43.4 45 50 55 60 65	1048 983.8 811.3 672.5 560.3 469.0	1396 1310 1081 895.8 746.3 624.7	2327 2184 1801 1493 1244 1041	4652 4369 3603 2986 2488 2083	4934 4655 3893 3270 2760 2339	14.13K 13.28K 10.97K 9109 7599 6367

Table IV (continued)

Resistance Versus Temperature °C

 	}	†	i		 	
Dash No.	11 17 23	12 18 24	13 19 25	15 21 27	14 20 26	16 22
Ohms @ 25°C	2252	3000	5000	10,000	10,000	30,000
Temp °C			Ohms			
70	394.5	525.4	875.7	1752	1990	5359
75	333.1	444.0	740.0	1479	1700	4529
80	282.7	376.9	628.1	1255	1458	3843
85	240.9	321.2	535.4	1070	1255	3273
90	206.1	274.9	458.2	915.2	1084	2799
95	177.1	236.2	393.7	786.4	939.3	2402
100	152.8	203.8	339.6	678.5	816.8	2069
105	132.3	176.4	294.0	587.5	712.6	1788
110	115.0	153.2	255.4	510.7	623.5	1550
115	100.2	133.6	222.6	444.9	547.3	1348
120	87.7	116.8	194.7	389.4	481.8	1176
125	77.0	102.5	170.8	341.9	425.3	1029
						

fixture volume. With switch A-A closed adjust E_{TH}/I_{TH} ratio equal to the zero-power resistance at 75°C. Allow 15 minutes (maximum) for stabilization. Set the bridge for null with the zero-power resistance value measured at 43.4°C. Prepare to measure the time from the instant that the switch is thrown to the position B-B to the time the bridge indicator passes through the null point. Throw the switch and record the time.

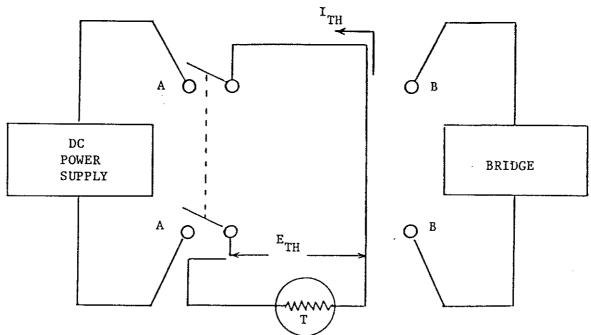


Figure 3. Test Circuit for Measuring Thermal Time Constant

3.4 Environmental

- 3.4.1 General The devices shall be glass encapsulated to form a hermetic seal to enable the device to meet the performance requirements of the specification and that the device shall not be affected physically, mechanically or electrically over the temperature range -80°C to -0°C + 5°C
- 3.4.2 Low Temperature Storage Thermistor shall be maintained at -80 +5° for a period of not less than three hours. The stabilized zero power resistance shall be measured initially and at completion per 3.3.1. The change in resistance at 40°C shall be less than 1%. The thermistors shall show no voids, cracks or other physical damage either prior to or at the completion of this test.
- 3.4.3 High Temperature Storage Thermistor shall be maintained at 125°C + 0°C, -8°C, for a period of 100 hours. The stabilized zero power resistance shall be measured initially and at completion per paragraph 3.3.1. The change in resistance at 40°C shall be less than 0.5%. The thermistors

- shall show no evidence of voids or cracks either prior to or at the completion of this test.
- 3.4.4 Thermal Shock Thermistors shall be tested in accordance with Method 107, Condition C, of MIL-STD-202. The zero power resistance shall be measured initially and at completion per 3.3.1. The thermistors shall show no voids, cracks or evidence of mechanical damage either prior to or at the completion of this test. The maximum change in resistance at 40°C as a result of this test shall be 1%.
- 3.4.5 Resistance to Soldering Heat Thermistors shall be tested per Method 210 of MIL-STD-202. The temperature of the molten solder shall be 300 ± 10°C. Immersion shall be to a point 1/8 to 3/16 inches from the thermistor body and the time of immersion shall be 2 ± 1 sec. Heat sinks shall be used and examination and measurements shall be after a cooling time of 24 ± 4 hours. The zero power measurement shall be made initially and after cooling per 3.3.1. Thermistors shall show no voids, cracks or evidence of mechanical damage either prior to or at the completion of this test. The maximum allowable change in resistance is ±0.5%.
- 3.4.6 Moisture Resistance Thermistors shall be tested in accordance with Method 106 of MIL-STD-202. Thermistors shall be measured at 40°C per 3.3.1 prior to and after the completion of the test. During the test the thermistor will be maintained at 100% of the maximum power specified. The final reading must be taken within 24 hours of the last cycle. The maximum allowable change in resistance shall be ±5%.
- 3.4.7 High Temperature Exposure Thermistors shall be maintained at 125°C + 0°C, -8°C for 1000 hours + 20 hours, -0 hours. Zero power resistance shall be measured at 40°C per 3.3.1 initially after the completion of 100 hours + 10 hours, -0 hours and at the completion of the test. The maximum allowable change in resistance at 100 hours shall be less than 0.5% and at completion 1%.
- 3.4.8 Vibration High Frequency Thermistors shall be tested per Method 204, Test Condition D, of MIL-STD-202. Thermistors shall be mounted by their leads with spacing of 1/4 inch maximum from mounting surface to body. Measurement shall be made during test to detect any discontinuity of 0.1 millisecond duration or greater. Zero power resistance shall be measured per 3.3.1 initially and at completion of test. The change in resistance shall be less than 1%. Thermistors shall show no voids, cracks or evidence of mechanical damage either prior to or at the completion of the test.
- 3.4.9 Immersion Thermistors shall be tested in accordance with Method 104, Condition B, of MIL-STD-202. Zero power resistance shall be measured at 40°C per 3.3.1 initially and within 24 hours after the last cycle. The maximum allowable change in resistance shall be less than 2%. The insulation resistance per 3.3.3 shall be measured within two hours of the completion of the last cycle.

- 4.0 QUALITY ASSURANCE PROVISIONS
- 4.1 Responsibility for Inspection The supplier shall be responsible for the performance of all inspection requirements as specified herein. Inspection records of examination and tests shall be kept complete and available.
 - 4.1.1 Test Equipment and Inspection Facilities The test equipment and inspection facilities shall be of sufficient accuracy to perform the required inspections. The supplier shall establish and maintain a calibration system of all instrumentation in accordance with MIL-C-45662.
 - 4.1.2 Qualification Inspection The thermistors shall be tested to demonstrate the capability to meet the specified requirements to the qualified construction, materials and processes.
 - 4.1.2.1 Sample A Sample consisting of 50 thermistors shall have 25 sample units of the lowest and 25 sample units of the highest resistance values.
 - 4.1.2.2 Test Data Each submission shall be accompanied by the test data obtained from these tests.
 - 4.1.2.3 Test Routine Sample units shall be subjected to the qualification inspection specified in Table V, in the order shown. All sample units with the exception of those in group IA shall be subjected to the inspection of Group I. The 50 sample units from Group I shall then be divided as specified in Table V for Group II thru V inclusive and subjected to the inspection for their particular Group.
 - 4.1.2.4 Resistance Temperature Characteristics The thermistors shall be stabilized at each of the ambient temperatures listed in Table VI for the Group III test. Zero power measurements shall be performed per 3.3.1 at each specified temperature, after a stabilization time equal to but not less than 12 seconds. The resistance shall be tabulated for each temperature.
 - 4.1.2.5 Retention of Qualification In order to retain qualification, the supplier shall forward at six month intervals a summary of Group A tests indicating as a minimum, the number of lots which passed, and the number which failed. All lots that fail shall be reported to NASA individually as they occur:

Table V
Qualification Inspection

Examination or Test	Requirement Paragraph	Number of Sample Units	Allowable Defectives l
Group I			
Visual and mechanical examination	3.2	All sample units ³	0
Zero-power resistance ²	3.3.1		
Group IA			
Solderability (If specified)	3.2.6	20 single or 10 both leads	1
Group II			
Short time load Insulation resistance Low temperature storage High temperature storage Dissipation constant ² Thermal time constant ² Terminal strength	3.3.2 3.3.3 3.4.2 3.4.3 3.3.4 3.3.5 3.2.4	10	1
Group III			
Resistance-temperature characteristic 2 Thermal shock Resistance to soldering heat (If applicable) Moisture resistance	4.1.2.5 3.4.4 3.4.5 3.4.6	10	1
Group IV			
High temperature exposure	3.4.7	10	1
Group V			
Vibration, high frequency Immersion	3.4.8 3.4.9	10	1

l Failure of the same thermistor in one or more tests of a group shall be charged as a single defective thermistor.

^{2.} Nondestructive tests.

^{3.} Sample units for Group IA shall not be subjected to Group I.

Table VI

Resistance-Temperature Characteristic Test Temperatures

Step	Temperature(C)
1	-80 ⁻⁰ +5
2	-35
3	-15
4	0
5	+25
6	+40 or +50
7	+70 or +75
8	+125

- 4.1.3 Quality Conformance Inspection Quality Conformance Inspection is performed to demonstrate the capability of the thermistor to meet the specified requirements with the established construction, design, material and processes. This inspection is performed on a deliverable product from a particular lot.
- 4.1.3.1 Inspection Lot The inspection lot shall consist of all of the thermistors with the same design and materials manufactured to the same production processes within a period not to exceed 6 weeks or 1000 units. All thermistors shall be identical in all respects and shall be directly interchangeable in form, fit and function with other thermistors in the lot.
- 4.1.3.2 Group A Inspection Group A inspection shall consist of the examination and tests specified in Table VII and shall be performed in the order therein on 100% of the inspection lot. The thermistors shall be stabilized at steps 4, 6 and 7 of Table VI in satisfying the requirements of Step 7 of Table VII. Zero power resistance shall be made per 3.3.1.

Table VII

Group A Inspection

	
Examination or Test 100% Inspection	Requirement Para.#
Visual & Mechanical	3.2
Zero-power resistance	3.3.1
Thermal Shock	3.4.4
High Temp. Storage	3.4.3
Zero-power resistance	3.3.1
Insulation resistance	3.3.3
Resistance-temperature characteristic	3.3.1
	Visual & Mechanical Zero-power resistance Thermal Shock High Temp. Storage Zero-power resistance Insulation resistance Resistance-temperature

5.0 PREPARATION FOR DELIVERY

5.1 Preservation and Packaging Preservation and packaging shall be level A or C, as specified (see 6.1).

5.1.1 Level A

- 5.1.1.1 Cleaning Thermistors shall be cleaned in accordance with MIL-P-116, process C-1.
- 5.1.1.2 Drying Thermistors shall be dried in accordance with one or more of the procedures listed in MIL-P-116. The procedure used shall not be injurious to the item.
- 5.1.1.3 Preservative Application None required.
- 5.1.1.4 Unit Packaging Thermistors shall be individually packaged in a manner to insure compliance with the Physical (Methods of Preservation) and General paragraphs of MIL-P-116, method IA8.

- 5.1.1.5 Intermediate Packaging Thermistors, packaged as described in 5.1.1.4, shall be placed in intermediate containers conforming to PPP-B-566 or PPP-B-676. Intermediate containers shall be uniform in size and shape, shall be of minimum cube and tare, and shall contain multiples of five unit packages, not to exceed 100 packages or ten pounds. No intermediate packaging is required when the total quantity shipped to a single destination is less than 100 units.
- 5.1.2 Level C Thermistors shall be preserved and packaged in a manner that will afford adequate protection against corrosion, deterioration, and physical damage during shipment from supply source to the first receiving activity for immediate use. This package may conform to the suppliers commercial practice for retail distribution when such meets the requirements of this level.
- 5.2 Packing Packing shall be level A, B, or C, as specified (see 6.1).
 - 5.2.1 Level A The packaged item(s) shall be packed in fiberboard containers conforming to PPP-B-636, weather resistant, style optional, special requirement. In lieu of the closure and waterproof requirements in the appendix of PPP-B-636, closures and waterproofing shall be accomplished by sealing the center seams, ends edges, and manufacturer's joints with waterproof tape, 2 inches wide, conforming to PPP-T-60, class 1 or PPP-T-76. Banding (reinforcement requirements) shall be applied in accordance with the appendix to PPP-B-636, using non-metallic or tape banding only.
 - 5.2.2 <u>Level B</u> The packaged item(s) shall be packed in fiberboard containers conforming to PPP-B-636, class domestic, style and use requirements optional. Closure shall be in accordance with the appendix thereto.
 - 5.2.3 Level C The packaged item(s) shall be packed in a manner that will afford adequate protection against damage during direct shipment from the supply source to the first receiving activity for immediate use. This pack shall conform to the applicable carrier rules and regulations and may be the supplier's commercial practice when such conforms to the requirements of this level.
- 5.3 Marking (see 6.1) In addition to any special marking required by the contract or order, each unit package, intermediate and exterior containers shall be marked in accordance with MIL-STD-129.
- 5.4 General Exterior containers shall be of a minimum tare and cube consistent with the protection required and shall contain equal quantities of identical items to the greatest extent possible.

NOTES

- 6.1 Ordering Data Procurement documents should specify the following:
 - (a) Title, number and date of this detail specification, solderability when required, and the complete part number (see 1.2.1).
 - (b) Levels of preservation and packaging and packing and applicable marking (see 5.0)
 - (c) Method of preservation and packaging of MIL-P-116, if other than method of IA8 (see 5.1).
 - (d) Number of unit packages if other than that specified in 5.1.1.5.
- 6.2 <u>Data Address</u> When supplemental data, reports, or information requests are to be transmitted to GSFC, the following address shall be used unless otherwise specified.

Parts Branch, Code 311 Goddard Space Flight Center Greenbelt, Maryland 20771

- 6.3 Qualification With respect to products requiring qualification, awards will be made only for products which have been tested and approved by GSFC before the time set for opening of bids. The attention of the suppliers is called to this requirement. Manufacturers should arrange to have qualification tests made on products which they propose to offer to GSFC to become eligible for awards of contracts or orders for products covered by this specification. The manufacturer shall bear the cost of qualification inspection to this specification. Information pertaining to qualification of products may be obtained from the Parts Branch, whose address is listed in 6.2.
- 6.4 WARNING. USE HEAT SINKS WHEN SOLDERING OR WELDING TO THERMISTOR LEADS.